

- ★ Super_Junction technology
- ★ Much lower Ron*A performance for On-state efficiency
- ★ Better efficiency due to very low FOM
- ★ Qualified for industrial grade applications according to JEDEC

600V Super Junction Power MOSFET

Product Summary



| BVDSS | RDS(ON) | ID |
|-------|---------|----|
| 600V | 530mΩ | 7A |

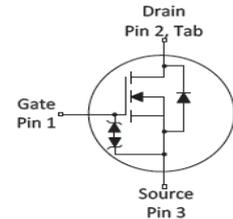
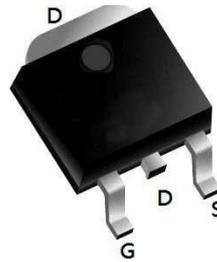
Description

The XR60R500 use super junction technology and design to provide excellent RDS(ON) with low gate charge. This super junction MOSFET fits the industry’s AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

The XR60R500 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

ESD(HBM):2000V

TO252-3L Pin Configuration



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|---------------------------------------|--|------------|-------|
| V _{DS} | Drain-Source Voltage | 600 | V |
| V _{GS} | Gate-Source Voltage | ±30 | V |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ^{1,6} | 7 | A |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ^{1,6} | 4 | A |
| I _{DM} | Pulsed Drain Current ² | 27 | A |
| EAS | Single Pulse Avalanche Energy ³ | 55 | mJ |
| I _{AS} | Avalanche Current | --- | A |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | 63 | W |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C |
| T _J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|------------------|--|------|------|------|
| R _{θJA} | Thermal Resistance Junction-Ambient ¹ | --- | 128 | °C/W |
| R _{θJC} | Thermal Resistance Junction-Case ¹ | --- | 2.09 | °C/W |

600V Super Junction Power MOSFET
Electrical Characteristics (T_J=25 °C, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|--|--|------|------|------|-------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250uA | 100 | --- | --- | V |
| ΔBV _{DSS} /ΔT _J | BV _{DSS} Temperature Coefficient | Reference to 25°C, I _D =1mA | --- | --- | --- | V/°C |
| R _{DS(ON)} | Static Drain-Source On-Resistance ² | V _{GS} =10V, I _D =1A | --- | 530 | 600 | mΩ |
| V _{GS(th)} | Gate Threshold Voltage | V _{GS} =V _{DS} , I _D =250uA | 3.0 | 3.5 | 4.0 | V |
| ΔV _{GS(th)} | V _{GS(th)} Temperature Coefficient | | --- | --- | --- | mV/°C |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} =100V, V _{GS} =0V, T _J =25°C | --- | --- | 1 | uA |
| | | V _{DS} =100V, V _{GS} =0V, T _J =100°C | --- | --- | 100 | |
| I _{GSS} | Gate-Source Leakage Current | V _{GS} =±10V, V _{DS} =0V | --- | --- | ±10 | nA |
| g _{fs} | Forward Transconductance | V _{DS} =5V, I _D =3.5A | --- | 5 | --- | S |
| R _g | Gate Resistance | V _{DS} =0V, V _{GS} =0V, f=1MHz | --- | 17 | --- | Ω |
| Q _g | Total Gate Charge | V _{DS} =480V, V _{GS} =10V, I _D =3A | --- | 10.8 | --- | nC |
| Q _{gs} | Gate-Source Charge | | --- | 2.8 | --- | |
| Q _{gd} | Gate-Drain Charge | | --- | 5.2 | --- | |
| T _{d(on)} | Turn-On Delay Time | V _{GS} =10V, V _{DS} =400V, R _G =10Ω, I _D =3A | --- | 11 | --- | ns |
| T _r | Rise Time | | --- | 25 | --- | |
| T _{d(off)} | Turn-Off Delay Time | | --- | 35 | --- | |
| T _f | Fall Time | | --- | 27 | --- | |
| C _{iss} | Input Capacitance | V _{DS} =100V, V _{GS} =0V, f=1MHz | --- | 317 | --- | pF |
| C _{oss} | Output Capacitance | | --- | 22 | --- | |
| C _{rss} | Reverse Transfer Capacitance | | --- | 7.8 | --- | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|--|---|------|------|------|------|
| I _S | Continuous Source Current ^{1,4} | V _G =V _D =0V, Force Current | --- | --- | 7 | A |
| V _{SD} | Diode Forward Voltage ² | V _{GS} =0V, I _S =3.5A, T _J =25°C | --- | --- | 1.2 | V |
| t _{rr} | Reverse Recovery Time | I _F =3.5A, di/dt=100A/μs, | --- | 190 | --- | nS |
| Q _{rr} | Reverse Recovery Charge | T _J =25°C | --- | 1.3 | --- | uC |

Note :

¹ The data is tested by surface mounted on a 1 inch² FR-4 board with 20Z copper.

² The data is tested by pulsed pulse width < 300us duty cycle < 2%

³ The EAS data shows Max. rating. The test condition is V_{RM}>0, V_{DD}=200V, V_{GS}=10V, L=50mH

⁴ The power dissipation is limited by 150°C junction temperature

⁵ The data is theoretically the same as I_{SD} and I_{DM}. In real applications, it should be limited by total power dissipation.

Typical Performance Characteristics

Fig 1. Output Characteristics ($T_j=25^{\circ}\text{C}$)

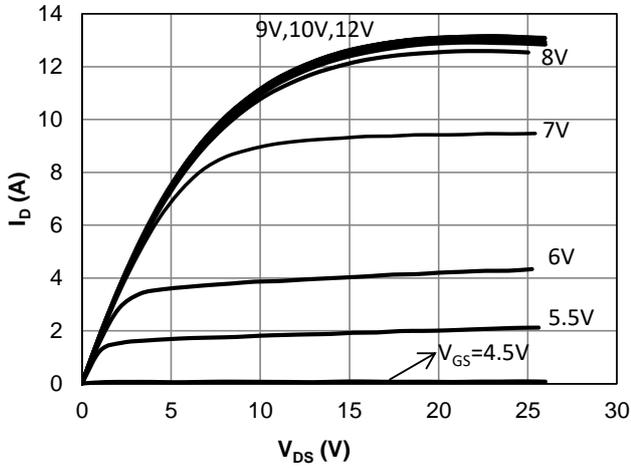


Fig 2. Output Characteristics ($T_j=150^{\circ}\text{C}$)

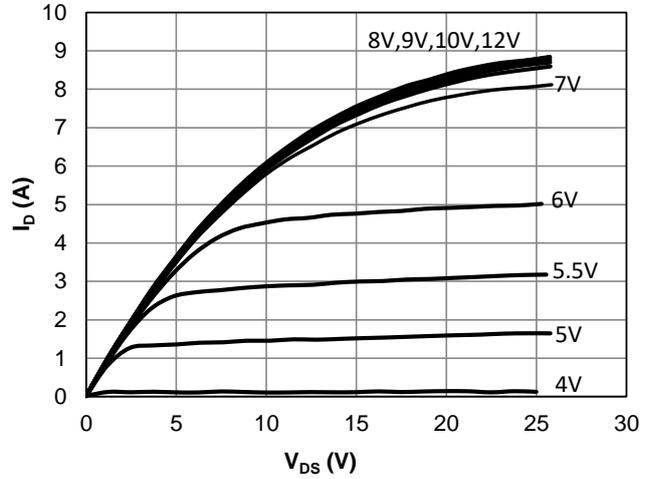


Fig 3: Transfer Characteristics

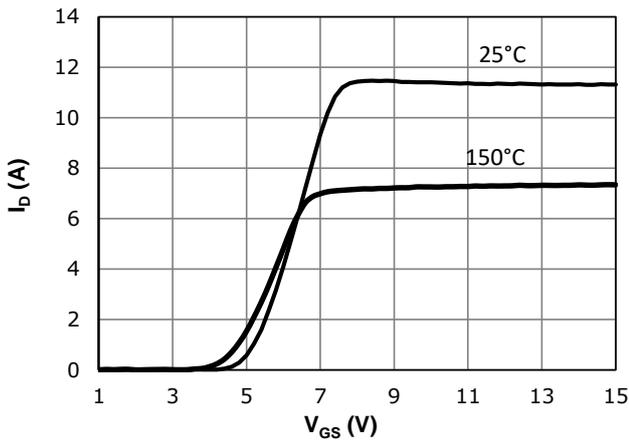


Fig 4: V_{TH} vs. T_j Temperature Characteristics

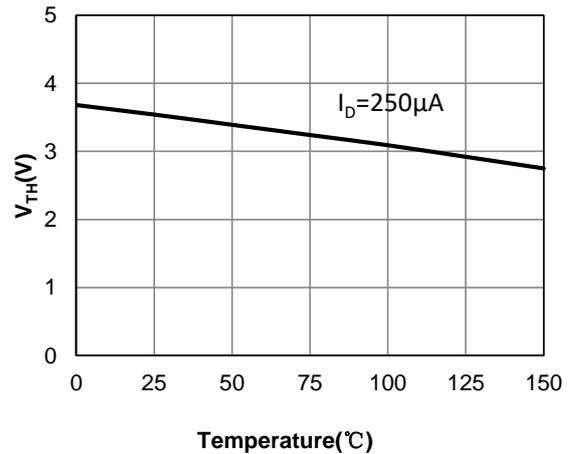


Fig 5: $R_{DS(on)}$ vs. I_{DS} Characteristics ($T_j=25^{\circ}\text{C}$)

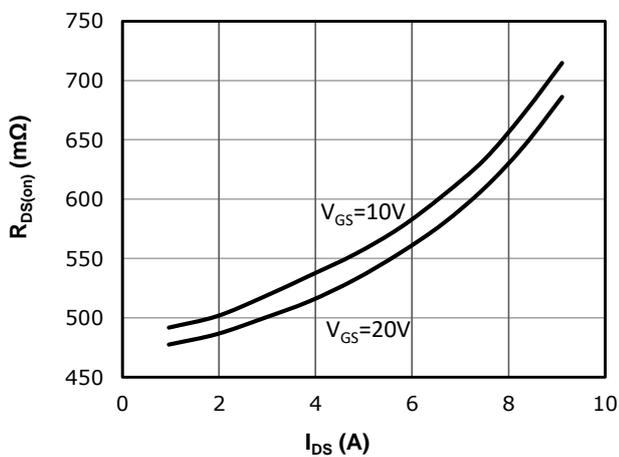
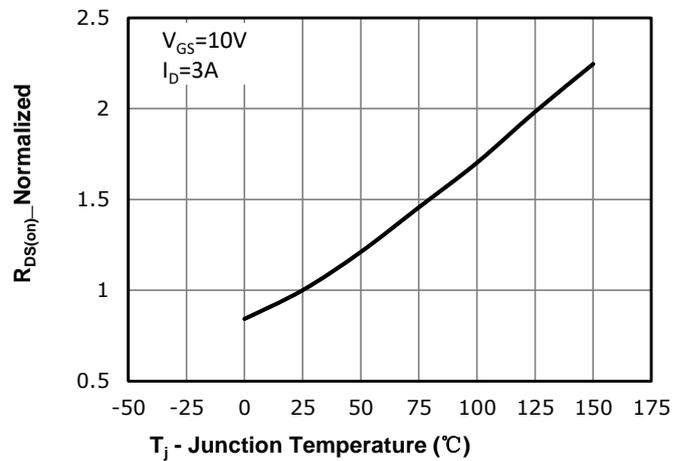


Fig 6: $R_{DS(on)}$ vs. Temperature



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Fig 7: BV_{DSS} vs. Temperature

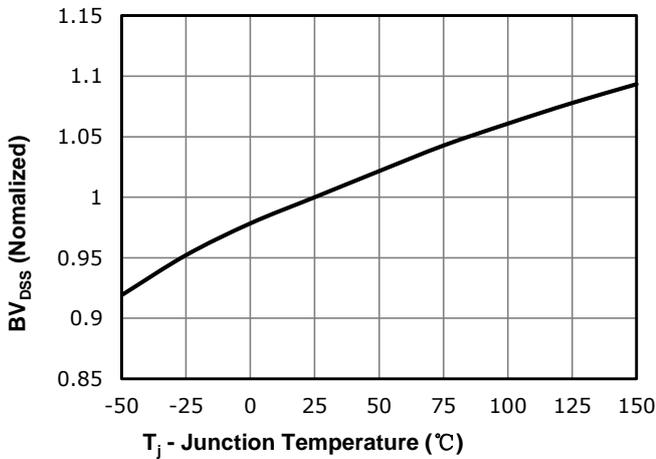


Fig 8: $R_{DS(on)}$ vs. Gate Voltage

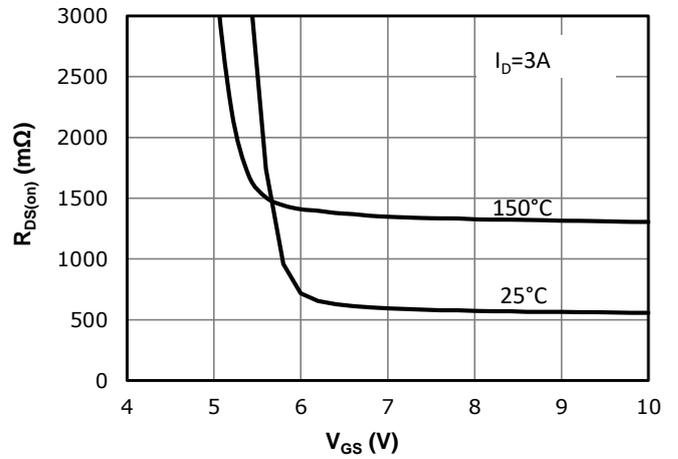


Fig 9: Body-diode Forward Characteristics

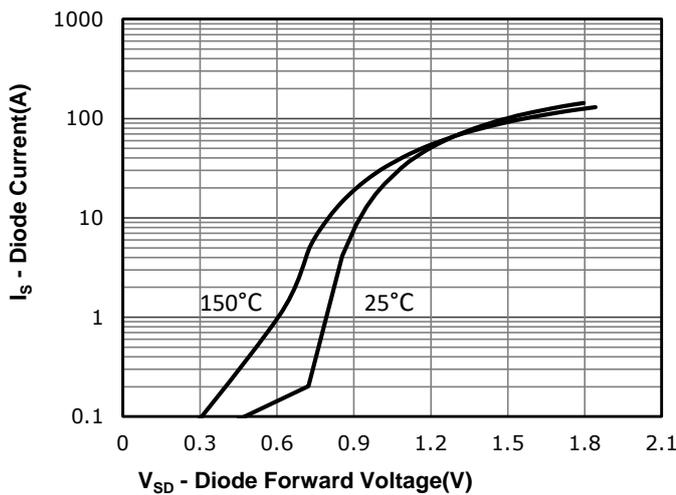


Fig 10: Gate Charge Characteristics

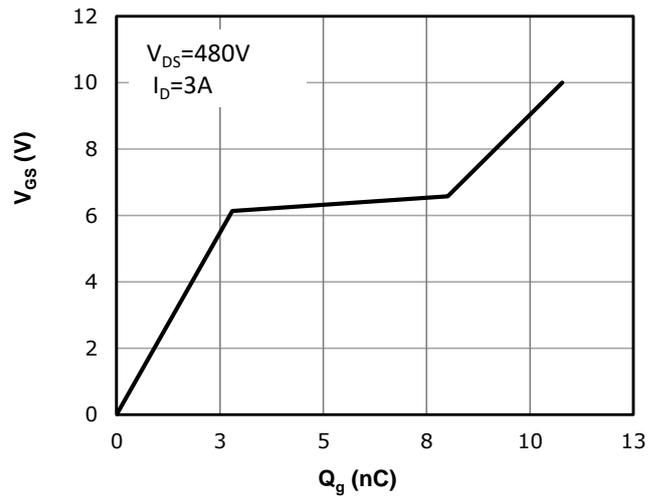


Fig 11: Capacitance Characteristics

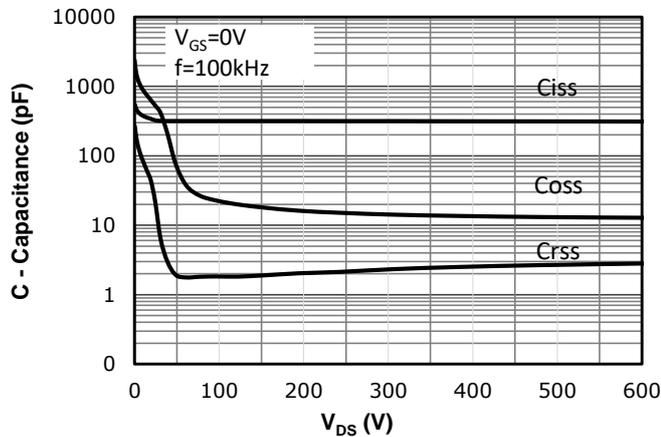
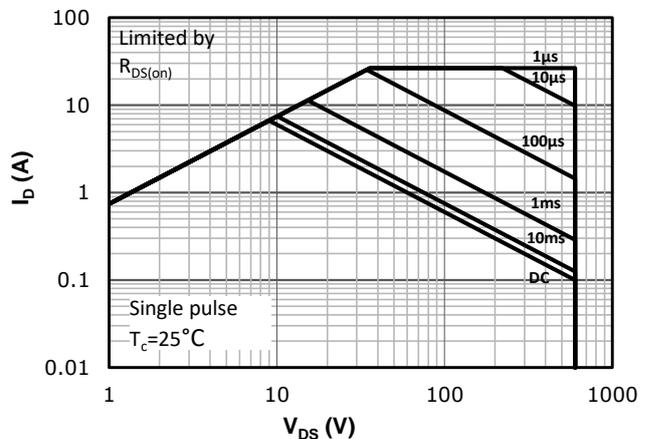
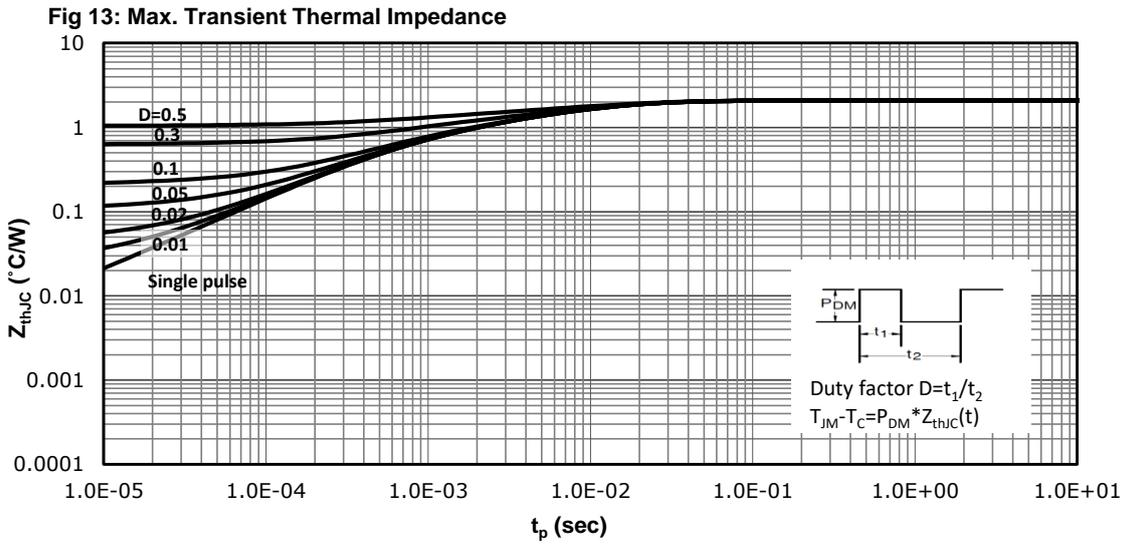


Fig 12: Safe Operating Area

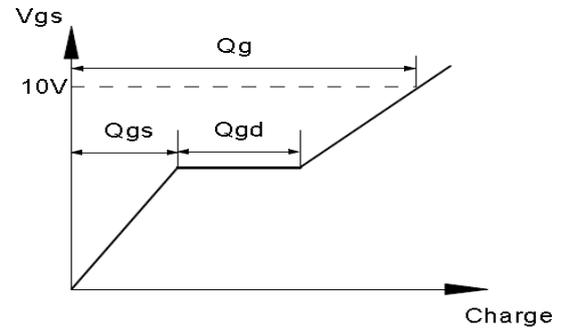
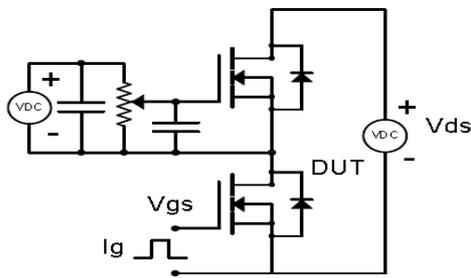


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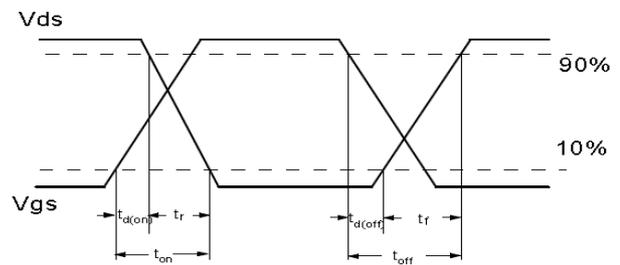
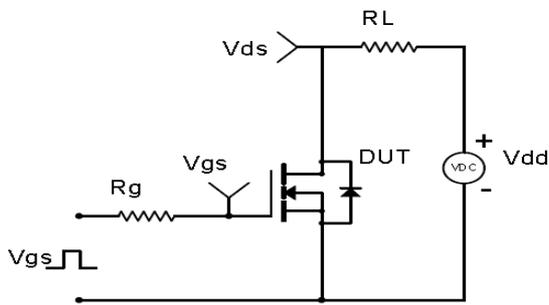


Test Circuit & Waveform

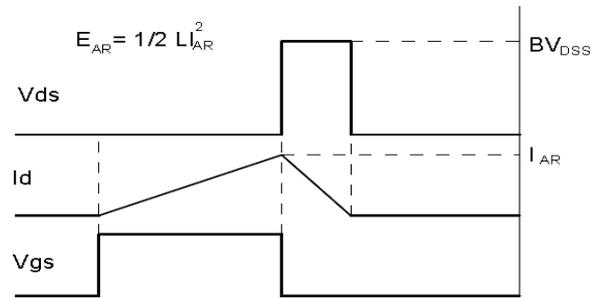
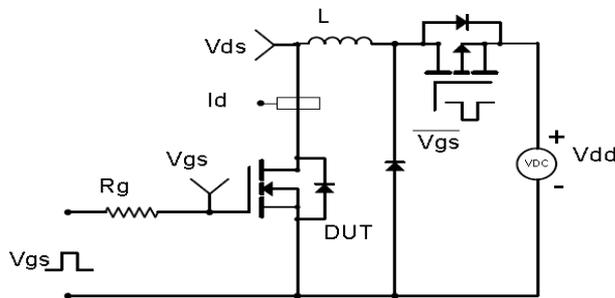
Gate Charge Test Circuit & Waveform



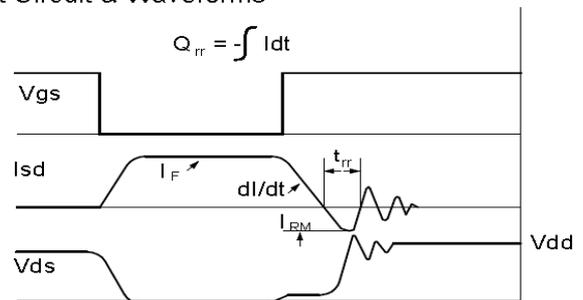
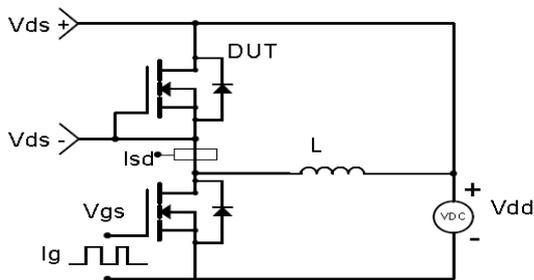
Resistive Switching Test Circuit & Waveforms



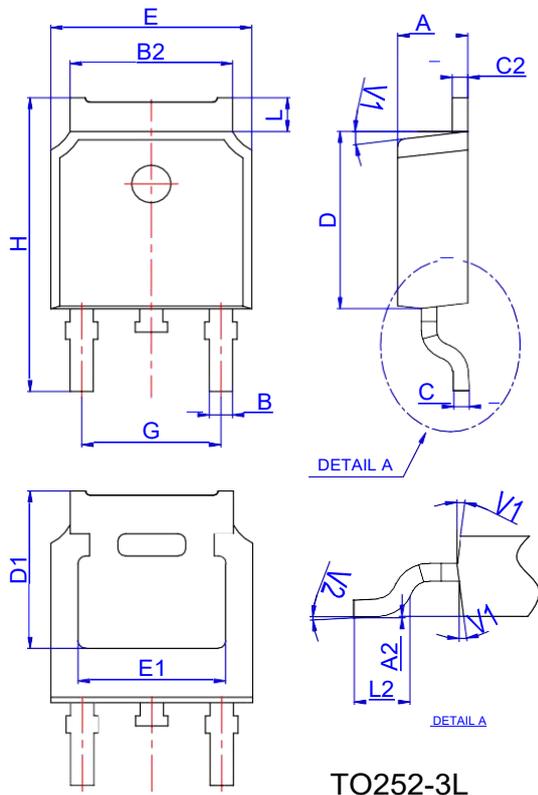
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

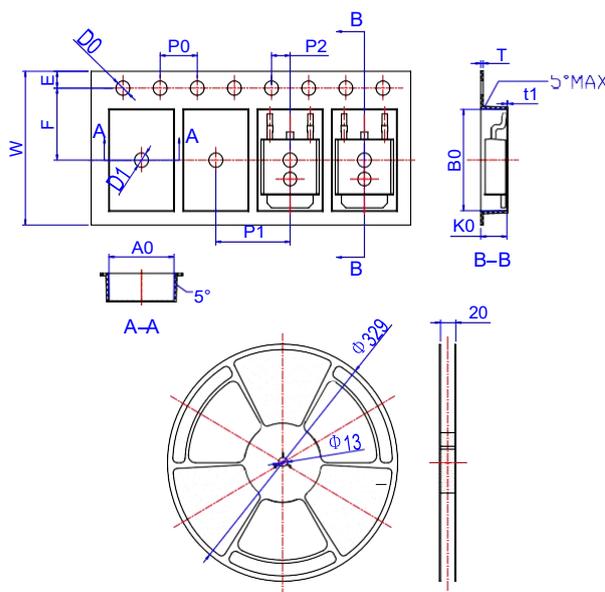


Package Mechanical Data-TO252-3L



| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|----------|------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.10 | | 2.50 | 0.083 | | 0.098 |
| A2 | 0 | | 0.10 | 0 | | 0.004 |
| B | 0.66 | | 0.86 | 0.026 | | 0.034 |
| B2 | 5.18 | | 5.48 | 0.202 | | 0.216 |
| C | 0.40 | | 0.60 | 0.016 | | 0.024 |
| C2 | 0.44 | | 0.58 | 0.017 | | 0.023 |
| D | 5.90 | | 6.30 | 0.232 | | 0.248 |
| D1 | 5.30REF | | | 0.209REF | | |
| E | 6.40 | | 6.80 | 0.252 | | 0.268 |
| E1 | 4.63 | | | 0.182 | | |
| G | 4.47 | | 4.67 | 0.176 | | 0.184 |
| H | 9.50 | | 10.70 | 0.374 | | 0.421 |
| L | 1.09 | | 1.21 | 0.043 | | 0.048 |
| L2 | 1.35 | | 1.65 | 0.053 | | 0.065 |
| V1 | | 7° | | | 7° | |
| V2 | 0° | | 6° | 0° | | 6° |

Reel Specification-TO252-3L



| Ref. | Dimensions | | | | | |
|------|-------------|-------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| W | 15.90 | 16.00 | 16.10 | 0.626 | 0.630 | 0.634 |
| E | 1.65 | 1.75 | 1.85 | 0.065 | 0.069 | 0.073 |
| F | 7.40 | 7.50 | 7.60 | 0.291 | 0.295 | 0.299 |
| D0 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 |
| D1 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 |
| P0 | 3.90 | 4.00 | 4.10 | 0.154 | 0.157 | 0.161 |
| P1 | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 |
| P2 | 1.90 | 2.00 | 2.10 | 0.075 | 0.079 | 0.083 |
| A0 | 6.85 | 6.90 | 7.00 | 0.270 | 0.271 | 0.276 |
| B0 | 10.45 | 10.50 | 10.60 | 0.411 | 0.413 | 0.417 |
| K0 | 2.68 | 2.78 | 2.88 | 0.105 | 0.109 | 0.113 |
| T | 0.24 | | 0.27 | 0.009 | | 0.011 |
| t1 | 0.10 | | | 0.004 | | |
| 10P0 | 39.80 | 40.00 | 40.20 | 1.567 | 1.575 | 1.583 |